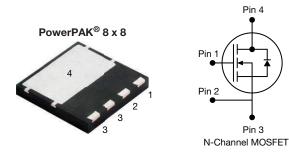
Vishay Siliconix



E Series Power MOSFET



PRODUCT SUMMARY				
V _{DS} (V) at T _J max.	650			
R _{DS(on)} typ. (Ω) at 25 °C	$V_{GS} = 10 V$	0.085		
Q _g max. (nC)	129			
Q _{gs} (nC)	20			
Q _{gd} (nC)	44			
Configuration	Single			

FEATURES

- Completely lead (Pb)-free device
- Low figure-of-merit (FOM) Ron x Qg
- Low input capacitance (Ciss)
- Reduced switching and conduction losses
- Ultra low gate charge (Q_q)
- Avalanche energy rated (UIS)
- Kelvin connection for reduced gate noise
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Renewable energy
 - Solar (PV inverters)

ORDERING INFORMATION	
Package	PowerPAK 8 x 8
Lead (Pb)-free and halogen-free	SiHH28N60E-T1-GE3

ABSOLUTE MAXIMUM RATINGS ($T_C = 25 \degree C$, unless otherwise noted)						
PARAMETER		SYMBOL	LIMIT	UNIT		
Drain-source voltage		V _{DS}	600	v		
Gate-source voltage		V _{GS}	± 30	v		
Continuous drain current (T _J = 150 °C)	V_{GS} at 10 V $T_C = 25 \degree C$ $T_C = 100 \degree C$	Ι _D	29			
	$T_{\rm C} = 100 ^{\circ}{\rm C}$		19	А		
Pulsed drain current ^a	I _{DM}	76				
Linear derating factor			1.6	W/°C		
Single pulse avalanche energy ^b		E _{AS}	353	mJ		
Maximum power dissipation		PD	202	W		
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +150	°C		
Drain-source voltage slope	T _J = 125 °C	dV/dt	70			
Reverse diode dV/dt ^c		uv/dt	13	V/ns		

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

b. V_{DD} = 140 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 Ω , I_{AS} = 5 A

c. $I_{SD} \leq I_D$, dl/dt = 100 A/µs, starting T_J = 25 °C

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1 For technical questions, contact: <u>hvm@vishay.com</u>



RoHS COMPLIANT HALOGEN



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THERMAL RESISTANCE RATI	NGS								
PARAMETER	SYMBOL	TYP.		MAX.		UNIT			
Maximum junction-to-ambient	R _{thJA}	38	38 50						
Maximum junction-to-case (Drain)	R _{thJC}	0.48 0.62				°C/W			
SPECIFICATIONS ($T_J = 25 \text{ °C}$, u		1			1	1			
PARAMETER	SYMBOL	TES	T CONDIT	IONS	MIN.	TYP.	MAX.	UNIT	
Static	1	1			r	1	Г		
Drain-source breakdown voltage	V _{DS}		= 0 V, I _D = 2		600	-	-	V	
V _{DS} temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C,	I _D = 10 mA	-	0.58	-	V/°C	
Gate-source threshold voltage (N)	V _{GS(th)}	V _{DS} =	$V_{GS}, I_D =$	250 µA	2.0	-	4.0	V	
Gate-source leakage	1	,	$V_{\rm GS} = \pm 20$	V	-	-	± 100	nA	
	I _{GSS}		V _{GS} = ± 30	V	-	-	± 1	μA	
Zero gate voltage drain current		V _{DS} =	$V_{DS} = 600 \text{ V}, \text{ V}_{GS} = 0 \text{ V}$		-	-	1		
	IDSS	V _{DS} = 480 V	′, V _{GS} = 0 \	/, T _J = 125 °C	-	-	10	μA	
Drain-source on-state resistance	R _{DS(on)}	$V_{GS} = 10 V$	I	_D = 14 A	-	0.085	0.098	Ω	
Forward transconductance	9 _{fs}	V _{DS}	= 30 V, I _D :	= 14 A	-	7.6	-	S	
Dynamic		1					1		
Input capacitance	C _{iss}	$V_{GS} = 0 V,$ $V_{DS} = 100 V,$ f = 1 MHz $V_{DS} = 0 V \text{ to } 480 V, V_{GS} = 0 V$		-	2614	-	pF		
Output capacitance	C _{oss}			-	125	-			
Reverse transfer capacitance	C _{rss}			-	5	-			
Effective output capacitance, energy related ^a	C _{o(er)}			-	86	-			
Effective output capacitance, time related ^b	C _{o(tr)}			-	444	-			
Total gate charge	Qg				-	86	129		
Gate-source charge	Q _{gs}	V _{GS} = 10 V	$V_{GS} = 10 \text{ V}$ $I_D = 10 \text{ A}, V_{DS} = 480 \text{ V}$		-	20	-	nC	
Gate-drain charge	Q _{gd}				-	44	-		
Turn-on delay time	t _{d(on)}				-	29	58		
Rise time	t _r	- Voo -	- 480 V In	– 14 A	-	75	113	1	
Turn-off delay time	t _{d(off)}	$V_{DD} = 480 \text{ V}, \text{ I}_D = 14 \text{ A},$ $V_{GS} = 10 \text{ V}, \text{ R}_g = 9.1 \Omega$		-	84	126	ns		
Fall time	t _f			-	54	81			
Gate input resistance	R _g	f = 1 MHz		0.2	0.5	1.0	Ω		
Drain-Source Body Diode Characteristic	, ÷	I							
Continuous source-drain diode current	۱ _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	29	A		
Pulsed diode forward current	I _{SM}			-	-	76			
Diode forward voltage	V _{SD}	T _J = 25 °C, I _S = 14 A, V _{GS} = 0 V		-	0.9	1.2	V		
Reverse recovery time	t _{rr}	$T_{J} = 25 \text{ °C, } I_{F} = I_{S} = 14 \text{ A,}$ dl/dt = 100 A/µs, V _R = 25 V		-	386	772	ns		
Reverse recovery charge	Q _{rr}			-	6	12	μC		
Reverse recovery current	I _{RRM}			-	25	-	A		

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DS}

b. Coss(tr) is a fixed capacitance that gives the same charging time as Coss while VDS is rising from 0 % to 80 % VDS



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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

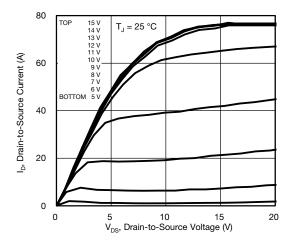


Fig. 1 - Typical Output Characteristics

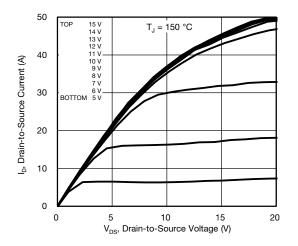


Fig. 2 - Typical Output Characteristics

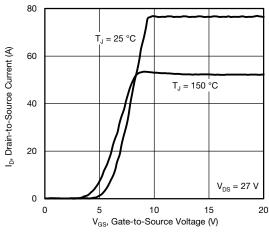


Fig. 3 - Typical Transfer Characteristics

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3.0 = 14 A Drain-to-Source On-Resistance (Normalized) 0.7 0.7 0.7 0.7 0.7 10 \ V_C R_{DS(on)}, I 0.5 0 -60 -40 -20 0 20 40 60 80 100 120 140 160 T_J, Junction Temperature (°C)

Fig. 4 - Normalized On-Resistance vs. Temperature

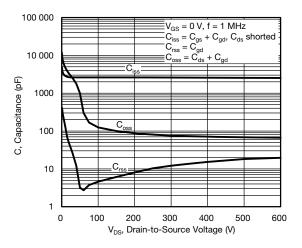


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

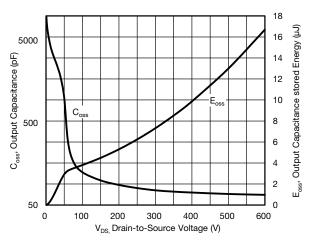


Fig. 6 - C_{OSS} and E_{OSS} vs. V_{DS}

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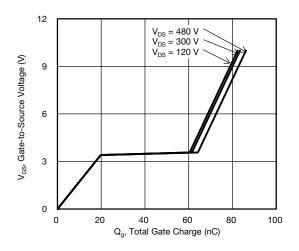


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

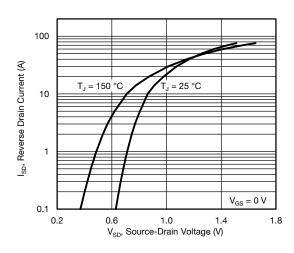


Fig. 8 - Typical Source-Drain Diode Forward Voltage

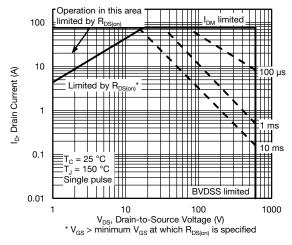


Fig. 9 - Maximum Safe Operating Area

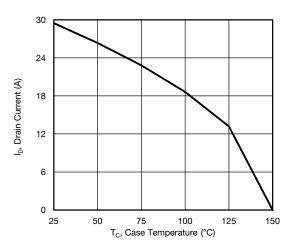


Fig. 10 - Maximum Drain Current vs. Case Temperature

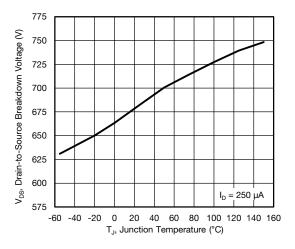
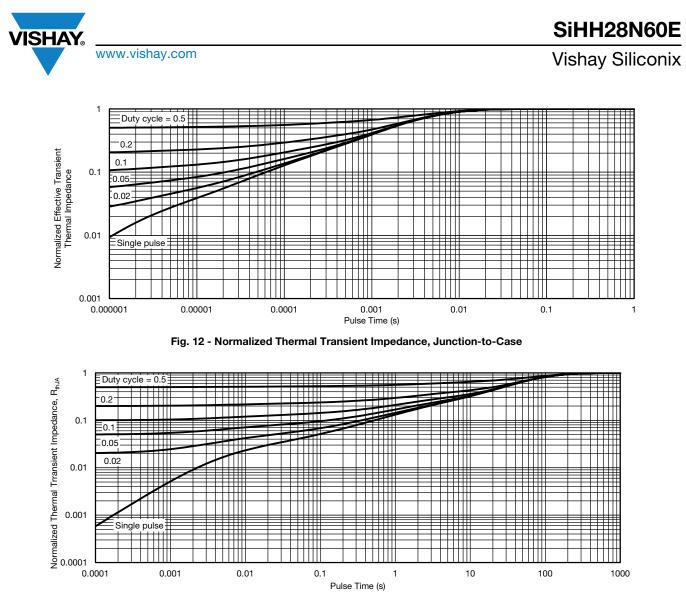


Fig. 11 - Temperature vs. Drain-to-Source Voltage

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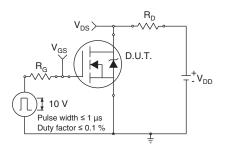


Fig. 14 - Switching Time Test Circuit

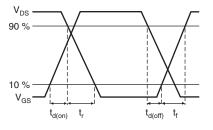
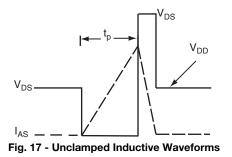


Fig. 15 - Switching Time Waveforms

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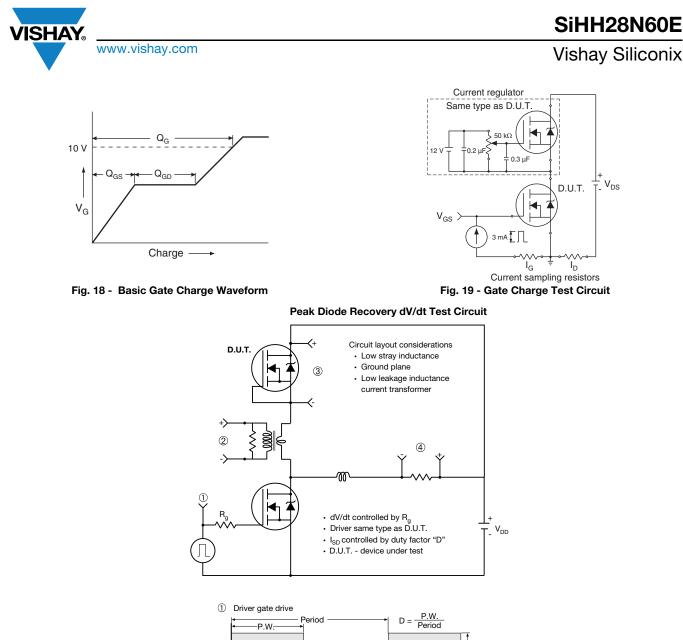
Vary t_p to obtain required I_{AS} R_G I_{AS} I_{AS} I

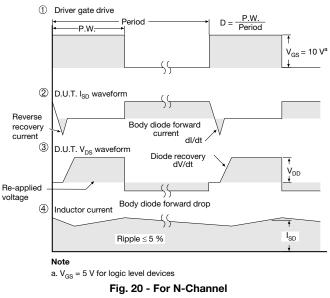
Fig. 16 - Unclamped Inductive Test Circuit



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